## Inductor Built-in Step-up "micro DC/DC" Converter (micro DC/DC)

$\approx$ GreenOperation-Compatible

## GENERAL DESCRIPTION

The XCL102/XCL103 series is a synchronous step-up micro DC/DC converter which integrates an inductor and a control IC in one tiny package $(2.0 \mathrm{~mm} \times 2.5 \mathrm{~mm}, \mathrm{~h}=1.0 \mathrm{~mm})$. A stable step-up power supply is configured using only two capacitors connected externally. An internal coil simplifies the circuit and enables minimization of noise and other operational trouble due to the circuit wiring. A wide operating voltage range of 0.9 V to 6.0 V enables support for applications that require an internally fixed output voltage ( 2.2 V to 5.5 V ). PWM control (XCL102) or automatic PWM/PFM switching control (XCL103) can be selected.

During the devices enter stand-by mode, XCL102D/XCL103D types prevent the application malfunction by CL Discharge Function which can quickly discharge the electric charge at the output capacitor (CL). XCL102/XCL103E types is able to drive Real Time Clock etc.

## IAPPLICATIONS

- Portable equipment
- Beauty \& health equipment
- Wearable devices
- Game \& Hobby
- PC Peripherals
- Devices with 1~3 Alkaline,

1~3 Nickel Hydride, 1 Lithium and 1 Li-ion

FEATURES
Input Voltage Range Fixed Output Voltage Oscillation Frequency Input Current
Output Current
Control Mode Selection
Load Transient Response
Protection Circuits
Functions

Output Capacitor
: Ceramic Capacitor
OperatingAmbient Temperature: $-40^{\circ} \mathrm{C} \sim+85^{\circ} \mathrm{C}$
Package : CL-2025-02
Environmentally Friendly : EU RoHS Compliant, Pb Free

■TYPICAL APPLICATION CIRCUIT


TYPICAL PERFORMANCE CHARACTERISTICS


## BLOCK DIAGRAM

## -XCL102D/XCL103D series



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.
* XCL102 series chooses only PWM control.
- XCL102E/XCL103E series


[^0]
## PRODUCT CLASSIFICATION

## -Ordering Information

XCL102(1)(2)(4)(4)(6)-(7) PWM control
XCL103(1)(2)(3)4)5(6)-7) PWM/PFM automatic switching control

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| (1) | Type | D | Refer to Selection Guide |
|  |  | E |  |
| (2)(3) | Output Voltage | 22~55 | Output Voltage options $\begin{aligned} \text { e.g. }) 3.3 \mathrm{~V} \rightarrow(2) & =3,(3)=3 \\ 5.0 \mathrm{~V} \rightarrow(2) & =5,(3)=0 \end{aligned}$ |
| (4) | Oscillation Frequency | 3 | 3.0 MHz |
| (5)(6)-7) ${ }^{(* 1)}$ | Package (Order Unit) | CR-G | CL-2025-02 (3,000pcs/Reel) |

${ }^{\left({ }^{*} 1\right)}$ The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully EU RoHS compliant.
-Selection guides

| TYPE | Output <br> Voltage | Chip <br> Enable | Soft-Start | CL Auto- <br> Discharge | Bypass <br> Switch | Load <br> Disconnection | Current Limit <br> (with integral latch) | Phort <br> with latch |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| D | Fixed | Yes | Fixed | Yes | No | Yes | Yes | Yes |
| E | Fixed | Yes | Fixed | No | Yes | No | Yes | Yes |

PIN CONFIGURATION


* If the pad needs to be connected to other pins, it should be connected to the GND.
(BOTTOM VIEW)
PIN ASSIGNMENT

| PIN NUMBER | PIN NAME | FUNCTIONS |
| :---: | :---: | :---: |
| 1 | V $_{\text {BAT }}$ | Power Input |
| 2 | GND | Ground |
| 3 | CE | Chip Enable |
| 4 | GND | Ground |
| 5 | Lx | Switching |
| 6 | V OUT | Output Voltage |
| 7 | L1 | Inductor Electrodes |
| 8 | L2 |  |

## FUNCTION CHART

| PIN NAME | SIGNAL | STATUS |
| :---: | :---: | :---: |
| CE | L | Stand-by |
|  | H | Active |

* Do not leave the CE pin open.

ABSOLUTE MAXIMUM RATINGS

| $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | RATINGS | UNITS |
| $\mathrm{V}_{\text {BAT }}$ Pin Voltage | $\mathrm{V}_{\text {BAT }}$ | $-0.3 \sim+7.0$ | V |
| Lx Pin Voltage | $\mathrm{V}_{\text {Lx }}$ | $-0.3 \sim+7.0$ | V |
| $\mathrm{~V}_{\text {OUT }}$ Pin Voltage | $\mathrm{V}_{\text {OUT }}$ | $-0.3 \sim+7.0$ | V |
| CE Pin Voltage | $\mathrm{V}_{\text {CE }}$ | $-0.3 \sim+7.0$ | V |
| Power Dissipation | Pd | $1000($ PCB mounted $)$ | mW |
| Operating Ambient Temperature | Topr | $-40 \sim+85$ | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | Tstg | $-55 \sim+125$ | ${ }^{\circ} \mathrm{C}$ |

[^1]
## ELECTRICAL CHARACTERISTICS <br> - XCL102/XCL103 Series

$\mathrm{Ta}=25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS | CIRCUIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage | $\mathrm{V}_{\text {IN }}$ |  | - | - | 6.0 | V | (1) |
| Output Voltage | $V_{\text {OUT }}$ | Voltage to start oscillation while $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {OUT }(\mathrm{T})} \times 1.03 \rightarrow \mathrm{~V}_{\text {OUT }(\mathrm{T})} \times 0.97$ | <E-1> | <E-2> | <E-3> | V | (5) |
| Operation Start Voltage | $\mathrm{V}_{\text {ST1 }}$ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ | - | - | 0.90 | V | (1) |
| Operation Hold Voltage | $\mathrm{V}_{\text {HLD }}$ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ | - | 0.65 | - | V | (1) |
| Quiescent Current (XCL103 only) | Iq | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BAT }}=\mathrm{V}_{\text {OUT(T) }}+0.5 \mathrm{~V}$ | - | 26 | 40 | $\mu \mathrm{A}$ | (3) |
| Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BAT }}=\mathrm{V}_{\text {OUT(T) }}{ }^{-0.2 V}$ | - | <E-5> | 3.0 | mA | (3) |
| Oscillation Frequency | fosc | $\mathrm{V}_{\text {BAT }}=\mathrm{V}_{\text {OUT }(T)} \times 0.5$, $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ | 2.4 | 3.0 | 3.6 | MHz | (1) |
| Maximum Duty Cycle | $\mathrm{D}_{\text {MAX }}$ | $\mathrm{V}_{\text {BAT }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {OUT(T) }}-0.2 \mathrm{~V}$ | 88 | 93 | 98 | \% | (5) |
| Minimum Duty Cycle | $\mathrm{D}_{\text {MIN }}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BAT }}=\mathrm{V}_{\text {OUT(T) }}+0.5 \mathrm{~V}$ | - | - | 0 | \% | (5) |
| PFM Switching Current (XCL103 only) | IPFM | $\mathrm{V}_{\mathrm{BAT}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}$ is selected with $\mathrm{V}_{\mathrm{OUT}(\mathrm{T})}$, Refer to Table 1 | - | 165 | 230 | mA | (1) |
| $\begin{gathered} \hline \text { Efficiency } \\ \text { (XCL103 only) } \end{gathered}$ | EFFI | $V_{\text {BAT }}=V_{\text {OUT(T) }} \times 0.6, R_{L}$ is selected with $V_{\text {OUt(T) }}$, Refer to Table 1 | - | $86^{(* 3)}$ | - | \% | (1) |
| Efficiency | EFFI | $\mathrm{V}_{\text {BAT }}=\mathrm{V}_{\text {OUT(T) }} \times 0.6, \mathrm{l}_{\text {OUT }}=100 \mathrm{~mA}$ | - | $90^{(* 3)}$ | - | \% | (1) |
| Stand-by Current | $\mathrm{I}_{\text {STB }}$ | $\mathrm{V}_{\mathrm{BAT}}=\mathrm{V}_{\mathrm{Lx}}=6.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V},{ }^{\left({ }^{*}\right)}$ | - | 0 | 1.0 | $\mu \mathrm{A}$ | (7) |
| Lx SW "Pch" ON Resistance | $\mathrm{R}_{\text {LXP }}$ | $\mathrm{V}_{\mathrm{BAT}}=\mathrm{V}_{\text {Lx }}=6.0 \mathrm{~V}$, $\mathrm{l}_{\text {OUT }}=200 \mathrm{~mA}$ | - | $0.3{ }^{\left({ }^{* 2}\right)}$ | - | $\Omega$ | (4) |
| Lx SW "Nch" ON <br> Resistance | $\mathrm{R}_{\text {LXN }}$ |  | - | $0.3{ }^{* * 3)}$ | - | $\Omega$ | (1) |
| Lx SW"H" Leakage Current | $\mathrm{I}_{\text {LXLH }}$ | $\mathrm{V}_{\mathrm{BAT}}=6.0, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Lx}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}$ | - | 0 | 1.0 | $\mu \mathrm{A}$ | (7) |
| Current Limit | ILIM | $\mathrm{V}_{\mathrm{BAT}}=\mathrm{V}_{\text {OUT }(\mathrm{T})}-0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{Lx}}=1 \Omega$ | <E-6> | <E-7> | <E-8> | A | (6) |
| Integral Latch Time | tlat | $\mathrm{V}_{\mathrm{BAT}}=\mathrm{V}_{\text {OUT(T) }}-0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{Lx}}=1 \Omega$, Time from current limit start to stop Lx oscillation | 25 | 100 | 365 | $\mu \mathrm{s}$ | (6) |
| Latch Release Voltage | $V_{\text {LAT_R }}$ | $\mathrm{R}_{\mathrm{L}}$ is selected with $\operatorname{Vout}(\mathrm{T})$, Refer to Table 1 | 0.9 | 1.2 | 1.5 | V | (1) |
| Short Protection Threshold Voltage | $\mathrm{V}_{\text {SHORT }}$ | $\mathrm{V}_{\mathrm{BAT}}=\mathrm{V}_{\text {OUT }(\mathrm{T})}{ }^{-0.2 V}, \mathrm{R}_{\mathrm{L}}=1 \Omega$ | - | (*3) | - | V | (1) |
| Soft-Start Time | $\mathrm{t}_{\text {ss }}$ | $\mathrm{V}_{\mathrm{BAT}}=\mathrm{V}_{\mathrm{OUT}(\mathrm{~T})} \times 0.6, \mathrm{~V}_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{OUT}(\mathrm{~T})} \times 0.9$ <br> After " H " is fed to CE, the time by when clocks are generated at Lx pin. | 0.2 | 0.5 | 1.0 | ms | (5) |
| $\mathrm{C}_{\mathrm{L}}$ Discharge Resistance (Type D only) | $\mathrm{R}_{\text {DCHG }}$ | $\mathrm{V}_{\mathrm{BAT}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=0 \mathrm{~V}$ | 100 | 180 | 400 | $\Omega$ | (2) |
| $\begin{gathered} \text { Bypass SW } \\ \text { Resistance (Type E only) } \end{gathered}$ | $\mathrm{R}_{\mathrm{BSW}}$ | $\mathrm{V}_{\text {BAT }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=0 \mathrm{~V}$ | 100 | 180 | 400 | $\Omega$ | (2) |
| CE "H" Voltage | $V_{\text {CEH }}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {OUT(T) }}-0.15 \mathrm{~V}$, Applied voltage to $\mathrm{V}_{\text {CE }}$, Voltage changes $L x$ to be generated. | 0.8 | - | 6.0 | V | (5) |
| CE "L" Voltage | $\mathrm{V}_{\text {cel }}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {OUT(T) }}-0.15 \mathrm{~V}$, Applied voltage to $\mathrm{V}_{\text {CE }}$, Voltage changes Lx to"H" level | GND | - | 0.2 | V | (5) |
| CE "H" Current | $\mathrm{I}_{\text {CEH }}$ | $\mathrm{V}_{\text {BAT }}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {Lx }}=6.0 \mathrm{~V} \mathrm{~V}_{\text {CE }}=6.0 \mathrm{~V}$, | -0.1 | - | 0.1 | $\mu \mathrm{A}$ | (2) |
| CE "L" Current | $\mathrm{I}_{\text {ceL }}$ | $\mathrm{V}_{\mathrm{BAT}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {Lx }}=6.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V}$ | -0.1 | - | 0.1 | $\mu \mathrm{A}$ | (2) |
| Inductance | L | Test Freq. $=1 \mathrm{MHz}$ | - | 1.5 | - | $\mu \mathrm{H}$ | - |
| Inductor Rated Current | $\mathrm{I}_{\text {ceL }}$ | $\Delta \mathrm{T}=+40 \mathrm{deg}$ | - | 1000 | - | mA | - |

[^2]
## ELECTRICAL CHARACTERISTICS (Continued)

Table 1. External Components $R_{L}$ Table

| $\mathrm{V}_{\text {OUT(T) }}$ | $\mathrm{R}_{\mathrm{L}}$ |
| :---: | :---: |
| UNITS:V | UNITS $: \Omega$ |
| $2.2 \leqq \mathrm{~V}_{\text {OUT(T) }}<3.1$ | 220 |
| $3.1 \leqq \mathrm{~V}_{\text {OUT(T) }}<4.3$ | 330 |
| $4.3 \leqq \mathrm{~V}_{\text {OUT }(\mathrm{T})} \leqq 5.5$ | 470 |

Table 2. SPEC Table

| NOMINAL | $\mathrm{V}_{\text {OUT }}$ |  |  | $\mathrm{I}_{\mathrm{DD}}$ | $\mathrm{I}_{\text {LIM }}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VOLTAGE | <E-1> | <E-2> | <E-3> | <E-5> | <E-6> | <E-7> | <E-8> |
| UNITS | V | V | V | mA | A | A | A |
| $\mathrm{V}_{\text {OUT(T) }}$ | MIN. | TYP. | MAX. | TYP. | MIN. | TYP. | MAX. |
| 2.2 | 2.156 | 2.200 | 2.244 | 0.705 | - | 1.11 | 2.30 |
| 2.3 | 2.254 | 2.300 | 2.346 | 0.736 | - | 1.14 | 2.30 |
| 2.4 | 2.352 | 2.400 | 2.448 | 0.767 | - | 1.17 | 2.30 |
| 2.5 | 2.450 | 2.500 | 2.550 | 0.797 | - | 1.19 | 2.30 |
| 2.6 | 2.548 | 2.600 | 2.652 | 0.828 | - | 1.22 | 2.30 |
| 2.7 | 2.646 | 2.700 | 2.754 | 0.858 | - | 1.24 | 2.30 |
| 2.8 | 2.744 | 2.800 | 2.856 | 0.889 | - | 1.26 | 2.30 |
| 2.9 | 2.842 | 2.900 | 2.958 | 0.919 | - | 1.28 | 2.30 |
| 3.0 | 2.940 | 3.000 | 3.060 | 0.950 | 0.96 | 1.30 | 2.30 |
| 3.1 | 3.038 | 3.100 | 3.162 | 0.981 | 0.97 | 1.30 | 2.30 |
| 3.2 | 3.136 | 3.200 | 3.264 | 1.011 | 0.97 | 1.30 | 2.30 |
| 3.3 | 3.234 | 3.300 | 3.366 | 1.042 | 0.98 | 1.30 | 2.30 |
| 3.4 | 3.332 | 3.400 | 3.468 | 1.072 | 0.98 | 1.30 | 2.30 |
| 3.5 | 3.430 | 3.500 | 3.570 | 1.103 | 0.99 | 1.30 | 2.30 |
| 3.6 | 3.528 | 3.600 | 3.672 | 1.134 | 0.99 | 1.30 | 2.30 |
| 3.7 | 3.626 | 3.700 | 3.774 | 1.164 | 1.00 | 1.30 | 2.30 |
| 3.8 | 3.724 | 3.800 | 3.876 | 1.195 | 1.00 | 1.30 | 2.30 |
| 3.9 | 3.822 | 3.900 | 3.978 | 1.225 | 1.01 | 1.30 | 2.30 |
| 4.0 | 3.920 | 4.000 | 4.080 | 1.256 | 1.01 | 1.30 | 2.30 |
| 4.1 | 4.018 | 4.100 | 4.182 | 1.286 | 1.02 | 1.30 | 2.30 |
| 4.2 | 4.116 | 4.200 | 4.284 | 1.317 | 1.02 | 1.30 | 2.30 |
| 4.3 | 4.214 | 4.300 | 4.386 | 1.348 | 1.03 | 1.30 | 2.30 |
| 4.4 | 4.312 | 4.400 | 4.488 | 1.378 | 1.03 | 1.30 | 2.30 |
| 4.5 | 4.410 | 4.500 | 4.590 | 1.409 | 1.04 | 1.30 | 2.30 |
| 4.6 | 4.508 | 4.600 | 4.692 | 1.439 | 1.04 | 1.30 | 2.30 |
| 4.7 | 4.606 | 4.700 | 4.794 | 1.470 | 1.05 | 1.30 | 2.30 |
| 4.8 | 4.704 | 4.800 | 4.896 | 1.501 | 1.06 | 1.30 | 2.30 |
| 4.9 | 4.802 | 4.900 | 4.998 | 1.531 | 1.06 | 1.30 | 2.30 |
| 5.0 | 4.900 | 5.000 | 5.100 | 1.562 | 1.07 | 1.30 | 2.30 |
| 5.1 | 4.998 | 5.100 | 5.202 | 1.592 | 1.07 | 1.30 | 2.30 |
| 5.2 | 5.096 | 5.200 | 5.304 | 1.623 | 1.08 | 1.30 | 2.30 |
| 5.3 | 5.194 | 5.300 | 5.406 | 1.653 | 1.08 | 1.30 | 2.30 |
| 5.4 | 5.292 | 5.400 | 5.508 | 1.684 | 1.09 | 1.30 | 2.30 |
| 5.5 | 5.390 | 5.500 | 5.610 | 1.715 | 1.09 | 1.30 | 2.30 |

## ■TEST CIRCUIT


※External Components
$\mathrm{C}_{\mathrm{IN}}: 10 \mu \mathrm{~F}$ (ceramic )
$\mathrm{C}_{\mathrm{L}}: 10 \mu \mathrm{~F}$ (ceramic
$\mathrm{L}: 1.5 \mu \mathrm{H}$ (selected inductor)
< Circuit No.(3) >

< Circuit No.(5) >

<Circuit No.(2) >

< Circuit No.(4) >

< Circuit No.(6) >

$<$ Circuit No. 7 >


## TYPICAL APPLICATION CIRCUIT



【Typical Examples】

|  | MANUFACTURER | PRODUCT NUMBER | VALUE |
| :---: | :---: | :---: | :---: |
| CIN | Taiyo Yuden | LMK107BBJ106MALT | $10 \mathrm{~V} / 10 \mathrm{uF}$ |
|  | Taiyo Yuden | TMK107BBJ106MA-T | $25 \mathrm{~V} / 10 \mathrm{uF}$ |
|  | TDK | C1608X5R0J106MT0A0E | $6.3 \mathrm{~V} / 10 \mathrm{uF}$ |
|  | TDK | C1608X5R1A106M | $10 \mathrm{~V} / 10 \mathrm{uF}$ |
| C CL | Taiyo Yuden | TMK107BBJ106MA-T | $25 \mathrm{~V} / 10 \mathrm{uF}$ |
|  | TDK | C1608X5R0J106MT0A0E | $6.3 \mathrm{~V} / 10 \mathrm{uF}$ |

* Select components appropriate to the usage conditions (ambient temperature, input \& output voltage).

While selecting a part, please concern about capacitance reduction and voltage durability.

* If $\mathrm{V}_{\mathrm{BAT}} \geqq 2 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}(\mathrm{T})} \geqq 3.5 \mathrm{~V}$ and the load current rises above 200 mA , use two or more in a parallel connection.

For the actual load capacitance, use a ceramic capacitor that ensures a capacitance equivalent to or greater than the TMK107BBJ106MA-T (Taiyo Yuden).
If using tantalum or low ESR electrolytic capacitors please be aware that ripple voltage will be higher due to the larger ESR (Equivalent Series Resistance) values of those types of capacitors. Please also note that the IC's operation may become unstable with such capacitors so that we recommend to test on the board before usage.

## OPERATIONAL EXPLANATION

The XCL102/XCL103 series consists of a reference voltage source, ramp wave circuit, error amplifier, PWM comparator, phase compensation circuit, N-channel driver transistor, P-channel synchronous rectification switching transistor and current limiter circuit.


The error amplifier compares the internal reference voltage with the resistors RFB1 and RFB2. Phase compensation is performed on the resulting error amplifier output, to input a signal to the PWM comparator to determine the turn-on time of the N -channel driver transistor during PWM operation. The PWM comparator compares, in terms of voltage level, the signal from the error amplifier with the ramp wave from the ramp wave circuit, and delivers the resulting output to the buffer driver circuit to cause the Lx pin to output a switching duty cycle. This process is continuously performed to ensure stable output voltage. The current feedback circuit monitors the N-channel driver transistor's turn-on current for each switching operation, and modulates the error amplifier output signal to provide multiple feedback signals. This enables a stable feedback loop even when a low ESR capacitor, such as a ceramic capacitor, is used, ensuring stable output voltage.
<Reference voltage source, soft start function>
The reference voltage forms a reference that is used to stabilize the output voltage of the IC.
After "H" level is fed to CE pin, the reference voltage connected to the error amp increases linearly during the soft start interval. This allows the voltage divided by the internal RFB1 and RFB2 resistors and the reference voltage to be controlled in a balanced manner, and the output voltage rises in proportion to the rise in the reference voltage. This operation prevents rush input current and enables the output voltage to rise smoothly.

## <Ramp Wave Circuit>

The ramp wave circuit determines switching frequency. The frequency is fixed internally at 3.0 MHz . The Clock generated is used to produce ramp waveforms needed for PWM operation, and to synchronize all the internal circuits.

## <Error Amplifier>

The error amplifier is designed to monitor output voltage. The amplifier compares the reference voltage with the feedback voltage divided by the internal resistors (RFB1 and RFB2). When the FB is lower than the reference voltage, output voltage of the error amplifier increases. The gain and frequency characteristics of the error amplifier are optimized internally.
< $\mathrm{V}_{\text {DDMAX }}>$
$V_{D D M A X}$ circuit compares the input voltage and the output voltage then it will select the higher one as the power supply for the IC.
<Shutdown function, load disconnection function>
The IC enters chip disable state by applying low level voltage to the CE pin. At this time, the N-channel and P-channel synchronous switching transistors are turned OFF

With the XCL102D/103D types, the orientation of the parasitic diode of the P-channel synchronous switching transistor is fixed at anode: $V_{\text {out }}$ and cathode: Lx during shutdown to break conduction from the input side to the output side by the parasitic diode of the P-channel synchronous switching transistor.
<PWM/PFM control circuit>
When PFM operates, the N -channel driver transistor turns on at the timing of the signal sent from the PWM comparator. The N -channel driver transistor remains on until the current in the coil reaches a constant current (l$l_{\text {PFM }}$ ). The PWM/PFM control circuit compares the signal sent from the PWM comparator to the time it takes the current in the coil to reach a constant current (l$l_{\text {PFM }}$ ), and outputs the pulse that results in a longer ontime of the N-channel driver transistor. This enables smooth switching between PWM and PFM. The XCL102 series directly outputs the signal that is sent from the PWM comparator.

## XCL102/XCL103 Series

## OPERATIONAL EXPLANATION (Continued)

<Maximum current limit function, short-circuit protection>
The maximum current limit function of XCL102D/E and XCL103D/E types monitors the current that flows in the N-channel driver transistor connected to the Lx pin, and consists of both maximum current limiting and a latch function. (Fig.1)
Short-circuit protection is a latch-stop function that activates when the output voltage drops below the short-circuit protection threshold voltage in the overcurrent state.(Fig.2)
(1) If the current flowing in the N -channel driver transistor exceeds the current limit value (equivalent to the peak coil current), the N -channel driver transistor turns off, and remains off during the clock interval. In addition, an integral latch timer starts the count.
(2) The N -channel driver transistor turns on at the next pulse. If in the overcurrent state at this time, the N -channel driver transistor turns off as in (1). The integral latch timer continues the count.
(3) If the count of the integral latch timer continues for $100 \mu \mathrm{~s}$ (typ.), a function that latches the N -channel driver transistor and P-channel synchronous switching transistor to the off state activates.
(4) If no longer in the overcurrent state at the next pulse, normal operation resumes. The integral latch timer stops the count.


Fig. 1
(5) If the output voltage $\mathrm{V}_{\text {OUT }}$ drops below the short-circuit protection threshold voltage $\mathrm{V}_{\text {SHORT }}$ during the count of the integral latch timer, a function that latches the N -channel driver transistor and P-channel synchronous switching transistor in the off state activates. The shortcircuit protection threshold voltage $\mathrm{V}_{\text {SHORT }}$ is a threshold voltage that is linked to the input voltage $\mathrm{V}_{\mathrm{BAT}}$.
(6) In the latched state, either restart by shutting down once with the CE pin, or resume operation by lowering the input voltage $V_{B A T}$ below the latch release voltage $\mathrm{V}_{\text {LAT_R }}\left(1.2 \mathrm{~V}\right.$ typ.). The soft start function operates during restart. During the soft-start interval $\mathrm{t}_{\mathrm{SS}}$, the integral latch timer and latch function are stopped.
(7) When the input voltage $\mathrm{V}_{\text {BAT }}$ is below the latch release voltage $\mathrm{V}_{\text {LAT_R }}(1.2 \mathrm{~V}$ typ.), the integral latch timer and latch function stop, but the current limiting function continues operating.

* Note that the current in the internal N -channel driver transistor is not the same as the output current lout.


Fig. 2

## OPERATIONAL EXPLANATION (Continued)

<Bypass switch>
At shutdown, XCL102E type and XCL103E type conduct between the BAT pin and $V_{\text {out }}$ pin by means of a bypass switch. If the output is shorted to ground, the current is limited by the resistance ( $\mathrm{R}_{\text {BSw }}$ ) of the bypass switch.

## < $\mathrm{C}_{\mathrm{L}}$ Discharge>

The XCL102D and XCL103D can discharge the electric charge at the output capacitor ( $C_{L}$ ) when a low signal to the CE pin which enables a whole IC circuit put into OFF state, is inputted via the N -channel transistor located between the $\mathrm{V}_{\text {оut }}$ pin and the GND pin. When the IC is disabled, electric charge at the output capacitor $\left(C_{L}\right)$ is quickly discharged so that it may avoid application malfunction. Discharge time of the output capacitor $\left(\mathrm{C}_{\mathrm{L}}\right)$ is set by the $\mathrm{C}_{\mathrm{L}}$ auto-discharge resistance $(\mathrm{R})$ and the output capacitor ( $\mathrm{C}_{\mathrm{L}}$ ). By setting time constant of a $\mathrm{C}_{\mathrm{L}}$ auto-discharge resistance value $\left[R_{D C H G}\right]$ and an output capacitor value ( $\left.C_{L}\right)$ as $\tau\left(\tau=C_{L} \times R_{D C H G}\right)$, discharge time of the output voltage after discharge via the $N$ channel transistor is calculated by the following formulas. However, the $C_{L}$ discharge resistance [ $\mathrm{R}_{\mathrm{DCHG}}$ ] is depends on the $\mathrm{V}_{\text {BAt }}$ or $\mathrm{V}_{\text {out }}$, so it is difficult to make sure the discharge time. We recommend that you fully check actual performance.

$$
V=V_{\text {оUT }} \times e-t / \tau \text { or } t=\tau \times \ln \left(V_{\text {OUT }} / V\right)
$$

V : Output voltage after discharge
$V_{\text {Out(T) }}$ : Target voltage
t : Discharge time
$\tau: \mathrm{C}_{\mathrm{L}} \times \mathrm{R}_{\mathrm{DCh}}$
$C_{\llcorner }$: Capacitance of Output capacitor ( $C_{\llcorner }$)
$R_{\text {dCHg }} \quad$ : $\mathrm{C}_{\mathrm{L}}$ Discharge resistance, it depends on supply voltage

Output Voltage Discharge characteristics
$R_{\text {DCHG }}=180 \Omega$ (TYP) $\mathrm{C}_{\mathrm{L}}=10 \mu \mathrm{~F}$


## NOTE ON USE

1) For the phenomenon of temporal and transitional voltage decrease or voltage increase, the IC may be damaged or deteriorated if IC is used beyond the absolute maximum ratings.
2) Spike noise and ripple voltage arise in a switching regulator as with a $D C / D C$ converter. These are greatly influenced by external component selection, such as the capacitance values, and board layout of external components. Once the design has been completed, verification with actual components should be done.
3) The DC/DC converter performance is greatly influenced by not only the ICs' characteristics, but also by those of the external components. Care must be taken when selecting the external components. Especially for $\mathrm{C}_{\mathrm{L}}$ load capacitor, it is recommended to use type B capacitors (JIS regulation) or X7R, X5R capacitors (EIA regulation).
4) Use a ground wire of sufficient strength. Ground potential fluctuation caused by the ground current during switching could cause the IC operation to become unstable, so reinforce the area around the GND pin of the IC in particular.
5) Please mount each external component as close to the IC as possible. Also, please make traces thick and short to reduce the circuit impedance.
6) With regard to the current limiting value ( $\mathrm{L}_{\text {LIM }}$ ), the actual coil current may at times exceed the electrical characteristics due to propagation delay inside the product.
7) The CE pin is a CMOS input pin. Do not use with the pin open. If connecting to the BAT pin or ground pin, use the resistor which is $1 \mathrm{M} \Omega$ or less. To prevent malfunctioning of the device connected to this product or the input/output due to short circuiting between pins, it is recommended that a resistor be connected.
8) The maximum current limiter controls the limit of the N -channel driver transistor by monitoring current flow. This function does not limit the current flow of the P -channel synchronous transistor. When used with the condition $\mathrm{V}_{\text {BAT }}>\mathrm{V}_{\text {OUT }}$ (input voltage higher than the output voltage), the IC may be destroyed if overcurrent flows to the P-channel synchronous switching transistor due to short-circuiting of the load or other reason.
9) When the device is used in high step-up ratio, the current limit function may not work during excessive load current. In this case, the maximum duty cycle limits maximum current. In this event, latching may not take place, because the maximum current limit cannot be detected.
10) On latch types, some board conditions may cause release from the maximum current limit, and the integrated latch time may become longer or latching may not take place.
11) On latch type, the maximum current limit may be detected, and this will cause the latch function to activate and stop operation after the soft start time elapses. In particular, note that the soft start time becomes shorter when the IC is used at high temperatures.
12) When the step-up voltage difference is small, the XCL102 series for PWM control may oscillate intermittently.
13) When the voltage boost difference is small, the current limiting function may not operate if the on time of the N -channel driver transistor is shorter than the propagation delay time of the current limit circuit. In this case, latching may not take place on a latch type because the maximum current limit is not detected.
14) $\quad V_{\text {BAT }}>V_{\text {OUT }}$ The case and Pch synchronous rectification switch Tr used in (input voltage more expensive than the output voltage). But the output voltage will be on and becomes equal to input voltage.
15) When connecting large-volume condenser $(100 \mu \mathrm{~F})$ etc. to the loading capacity, a protection circuit of IC moves, and the output voltage doesn't stand up.
16) When input voltage and output voltage are low, integral latch function and short-circuit protection may not operate. We recommend that you fully check actual performance.
17) TOREX places an importance on improving our products and its reliability. However, by any possibility, we would request user fail-safe design and post-aging treatment on system or equipment.

## ■NOTE ON USE(Continued)

18) Instructions of pattern layouts

The operation may become unstable due to noise and/or phase lag from the output current when the wire impedance is high, please place the input capacitor $\left(\mathrm{C}_{\mathrm{IN}}\right)$ and the output capacitor $\left(\mathrm{C}_{\mathrm{L}}\right)$ as close to the IC as possible.
(1) In order to stabilize $V_{B A T}$ voltage level, we recommend that a by-pass capacitor ( $C_{I N}$ ) be connected as close as possible to the $V_{B A T}$ pin, GND pin.
(2) Please mount each external component as close to the IC as possible.
(3) Wire external components as close to the IC as possible and use thick, short connecting traces to reduce the circuit impedance.
(4) Make sure that the GND traces are as thick as possible, as variations in ground potential caused by high ground currents at the time of switching may result in instability of the IC.
(5) This series' internal driver transistors bring on heat because of the output current and ON resistance of P-channel and N-channel MOS driver transistors. Please consider the countermeasures against heat if necessary.
19) Please make the equipped location accuracy within the 0.05 mm as a careful point on the mounting.
<Reference pattern layout>

<TOP VIEW >

<BOTTOM VIEW>

## ■TYPICAL PERFORMANCE CHARACTERISTICS

## (1) Output Voltage vs Output Current



XCL102D503CR-G/XCL102E503CR-G

(2) Efficiency vs Output Current


XCL103D333CR-G/XCL103E333CR-G


## ■TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(2) Efficiency vs Output Current (Continued)

(3) Ripple Voltage vs Output Current






## TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(4) Output Voltage vs Ambient Temperature

(5) Frequency vs Ambient Temperature


XCL102D503CR-G/XCL102E503CR-G

(6) Stand-by Current vs Ambient Temperature

XCL102D503CR-G/XCL102E503CR-G


## TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(7) Load Transient Response

- $\mathrm{XCL} 102 \mathrm{D} 503 \mathrm{CR}-\mathrm{G}, \mathrm{V}_{\text {IN }}=3.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=5.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1.0 \mathrm{~mA} \Leftrightarrow 300 \mathrm{~mA}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

- $\mathrm{XCL} 103 \mathrm{D} 503 \mathrm{CR}-\mathrm{G}, \mathrm{V}_{\mathrm{IN}}=3.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=5.0 \mathrm{~V}$, $\mathrm{I}_{\text {OUT }}=1.0 \mathrm{~mA} \Leftrightarrow 300 \mathrm{~mA}, \mathrm{Ta}=25^{\circ} \mathrm{C}$



## PACKAGING INFORMATION

## -CL-2025-02 (unit: mm)



Reference Pattern Layout (unit: mm)


Reference Metal Mask Design (unit: mm)

*Recommend mounting accuracy within 0.05 mm for CL-2025-02

## MARKING RULE

- CL-2025-02

(1) represents products series

| MARK | PRODUCT SERIES |
| :---: | :---: |
| 2 | XCL102 |
| 3 | XCL $103^{* * * * * * * * *-G ~}$ |

(2) represents integer and oscillation frequency of the output voltage

| MARK | Type | OUTPUT VOLTAGE(V) | Oscillation Frequency(MHz) | PRODUCT SERIES |
| :---: | :---: | :---: | :---: | :---: |
| 2 | D | 2.x | 3.0 | XCL102/3D2*3**-G |
| 3 |  | $3 . \mathrm{x}$ |  | XCL102/3D3*3**-G |
| 4 |  | 4.x |  | XCL102/3D4*3**-G |
| 5 |  | 5.x |  | XCL102/3D5*3**-G |
| C | E | 2.x | 3.0 | XCL102/3E2*3**-G |
| D |  | 3.x |  | XCL102/3E3*3**-G |
| E |  | 4.x |  | XCL102/3E4*3**-G |
| F |  | 5.x |  | XCL102/3E5*3**-G |

(3) represents the decimal part of output voltage

| OUTPUT VOLTAGE(V) | MARK | PRODUCT SERIES |
| :---: | :---: | :---: |
| X. 0 | 0 | XCL102/3**03**-G |
| X. 1 | 1 | XCL102/3**13**-G |
| X. 2 | 2 | XCL102/3**23**-G |
| X. 3 | 3 | XCL102/3**33**-G |
| X. 4 | 4 | XCL102/3**43**-G |
| X. 5 | 5 | XCL102/3**53**-G |
| X. 6 | 6 | XCL102/3**63**-G |
| X. 7 | 7 | XCL102/3**73**-G |
| X. 8 | 8 | XCL102/3**83**-G |
| X. 9 | 9 | XCL102/3**93**-G |

(4),5) represents production lot number

01~09, OA~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ in order.
(G, I, J, O, Q, W excluded)
Note: No character inversion used.

1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
2. The information in this datasheet is intended to illustrate the operation and characteristics of our products. We neither make warranties or representations with respect to the accuracy or completeness of the information contained in this datasheet nor grant any license to any intellectual property rights of ours or any third party concerning with the information in this datasheet.
3. Applicable export control laws and regulations should be complied and the procedures required by such laws and regulations should also be followed, when the product or any information contained in this datasheet is exported.
4. The product is neither intended nor warranted for use in equipment of systems which require extremely high levels of quality and/or reliability and/or a malfunction or failure which may cause loss of human life, bodily injury, serious property damage including but not limited to devices or equipment used in 1) nuclear facilities, 2) aerospace industry, 3) medical facilities, 4) automobile industry and other transportation industry and 5) safety devices and safety equipment to control combustions and explosions. Do not use the product for the above use unless agreed by us in writing in advance.
5. Although we make continuous efforts to improve the quality and reliability of our products; nevertheless Semiconductors are likely to fail with a certain probability. So in order to prevent personal injury and/or property damage resulting from such failure, customers are required to incorporate adequate safety measures in their designs, such as system fail safes, redundancy and fire prevention features.
6. Our products are not designed to be Radiation-resistant.
7. Please use the product listed in this datasheet within the specified ranges.
8. We assume no responsibility for damage or loss due to abnormal use.
9. All rights reserved. No part of this datasheet may be copied or reproduced unless agreed by Torex Semiconductor Ltd in writing in advance.

[^0]:    * Diodes inside the circuits are ESD protection diodes and parasitic diodes.
    * XCL103 series chooses only PWM control.

[^1]:    *GND are standard voltage for all of the voltage.

[^2]:    $\mathrm{V}_{\text {OUT(T): }}$ :Target Voltage
    Test Conditions: unless otherwise stated, $\mathrm{V}_{\mathrm{BAT}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=3.3 \mathrm{~V}, \mathrm{Lx}: \mathrm{OPEN}, \mathrm{R}_{\mathrm{Lx}}=56 \Omega$
    ${ }^{\left({ }^{*} 1\right)}$ XCL102D/XCL103D: $V_{\text {OUT }}=0 V, \quad$ XCL102E/XCL103E : $V_{\text {OUT }}=O P E N$
    ${ }^{\left({ }^{*} 2\right)}$ Design value for the XCL103D
    ${ }^{(33)}$ Designed value

